

## 3A, 400V - 1000V Glass Passivated Bridge Rectifier

### FEATURES

- Glass passivated junction
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_{F(AV)}$	3	A
$V_{RRM}$	400 - 1000	V
$I_{FSM}$	110	A
$T_{JMAX}$	150	°C
Package	YBS	
Configuration	Quad	

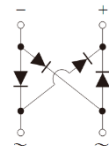
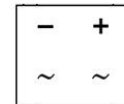
### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- TV
- Monitor


**YBS**

### MECHANICAL DATA

- Case: YBS
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.22g (approximately)



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	YBS 3004G	YBS 3005G	YBS 3006G	YBS 3007G	UNIT
Marking code on the device		YBS 3004G	YBS 3005G	YBS 3006G	YBS 3007G	
Repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	560	700	V
Forward current	$I_{F(AV)}$	3				A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	25°C	110			A
		125°C	88			
Surge peak forward current, 1 ms single half sine-wave superimposed on rated load	$I_{FSM}$	25°C	220			A
		125°C	175			
$I^2t$ value (of a surge on-state current) <sup>(1)</sup>	$I^2t$	50				A <sup>2</sup> s
Junction temperature	$T_J$	-55 to +150				°C
Storage temperature	$T_{STG}$	-55 to +150				°C

#### Note:

1. Pulse test with PW=8.3 ms single half sine-wave

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>LIMIT</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	25	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	80	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	28	°C/W

**Thermal Performance Note:** Units mounted on recommended PCB (16mm x 16mm Cu pad test board)

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage per diode <sup>(1)</sup>	$I_F = 1.5\text{A}, T_J = 25^\circ\text{C}$	$V_F$	0.89	1.02	V
	$I_F = 3.0\text{A}, T_J = 25^\circ\text{C}$		0.93	1.10	V
	$I_F = 1.5\text{A}, T_J = 125^\circ\text{C}$		0.76	0.90	V
	$I_F = 3.0\text{A}, T_J = 125^\circ\text{C}$		0.82	1.00	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>	$T_J = 25^\circ\text{C}$	$I_R$	-	5	$\mu\text{A}$
	$T_J = 125^\circ\text{C}$		-	100	$\mu\text{A}$
Junction capacitance	1 MHz, $V_R = 4.0\text{V}$	$C_J$	33	-	pF

**Notes:**

1. Pulse test with  $PW = 0.3\text{ ms}$
2. Pulse test with  $PW = 30\text{ ms}$

<b>ORDERING INFORMATION</b>				
<b>PART NO.</b>	<b>PACKING CODE</b>	<b>PACKING CODE SUFFIX</b>	<b>PACKAGE</b>	<b>PACKING</b>
YBS30xxG (Note 1, 2)	RA	G	YBS	3,000 / 13" Plastic reel

**Notes:**

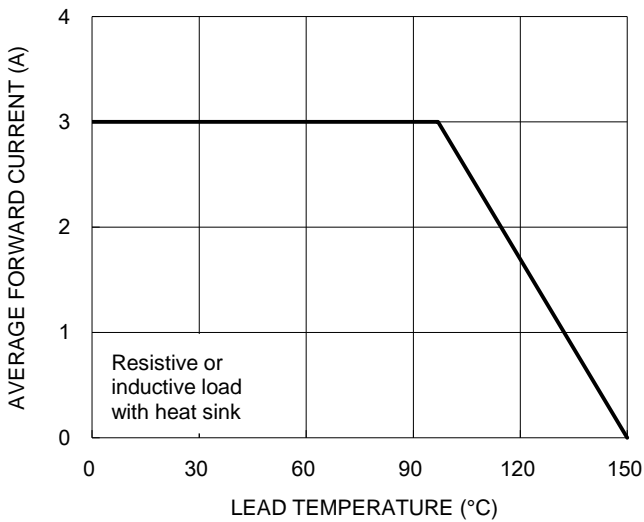
1. "xx" defines voltage from 400V (YBS3004G) to 1000V (YBS3007G)
2. Whole series with green compound (halogen-free)

<b>EXAMPLE</b>				
<b>EXAMPLE P/N</b>	<b>PART NO.</b>	<b>PACKING CODE</b>	<b>PACKING CODE SUFFIX</b>	<b>DESCRIPTION</b>
YBS3007G RAG	YBS3007G	RA	G	Green compound

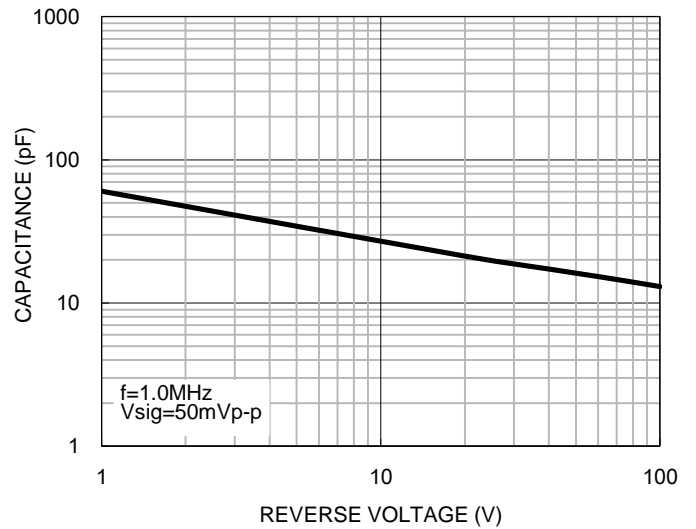
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

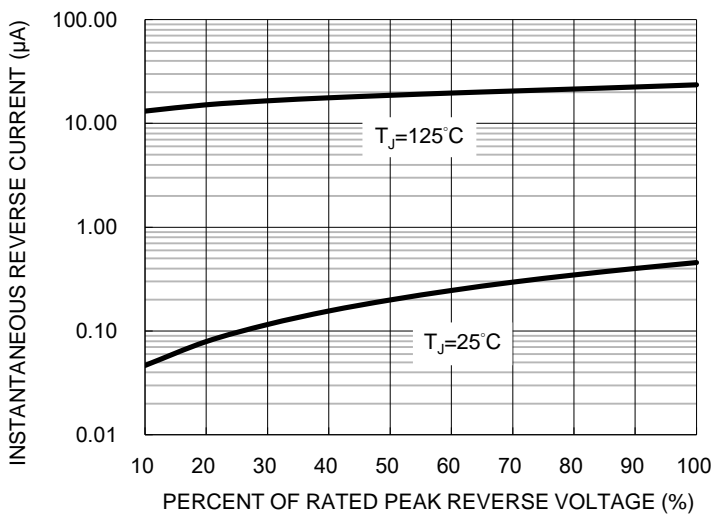
**Fig1. Forward Current Derating Curve**



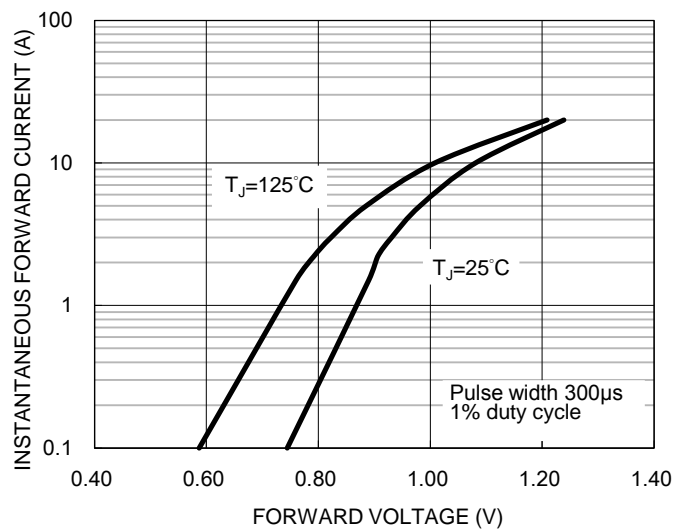
**Fig2. Typical Junction Capacitance**



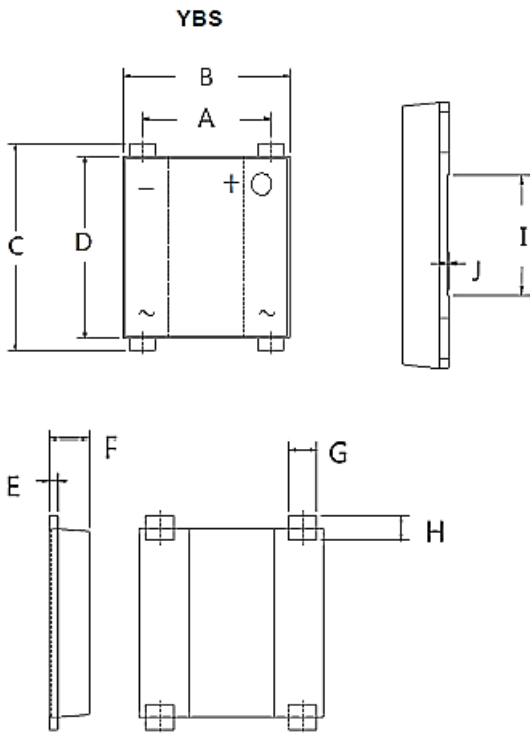
**Fig3. Typical Reverse Characteristics**



**Fig4. Typical Forward Characteristics**

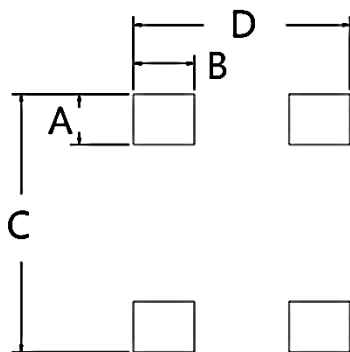


**PACKAGE OUTLINE DIMENSIONS**



DIM	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	5.00	5.20	0.197	0.205
B	6.50	6.70	0.256	0.264
C	7.90	8.60	0.311	0.339
D	7.20	7.40	0.283	0.291
E	0.27	0.40	0.011	0.016
F	1.30	1.50	0.051	0.059
G	0.95	1.15	0.037	0.045
H	0.70	1.05	0.028	0.041
I	2.90	3.10	0.114	0.122
J	0.04	0.08	0.002	0.003

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	1.80	0.070
B	2.00	0.078
C	9.15	0.360
D	7.10	0.279

**MARKING DIAGRAM**



P/N = Marking Code  
 YW = Date Code  
 F = Factory Code

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